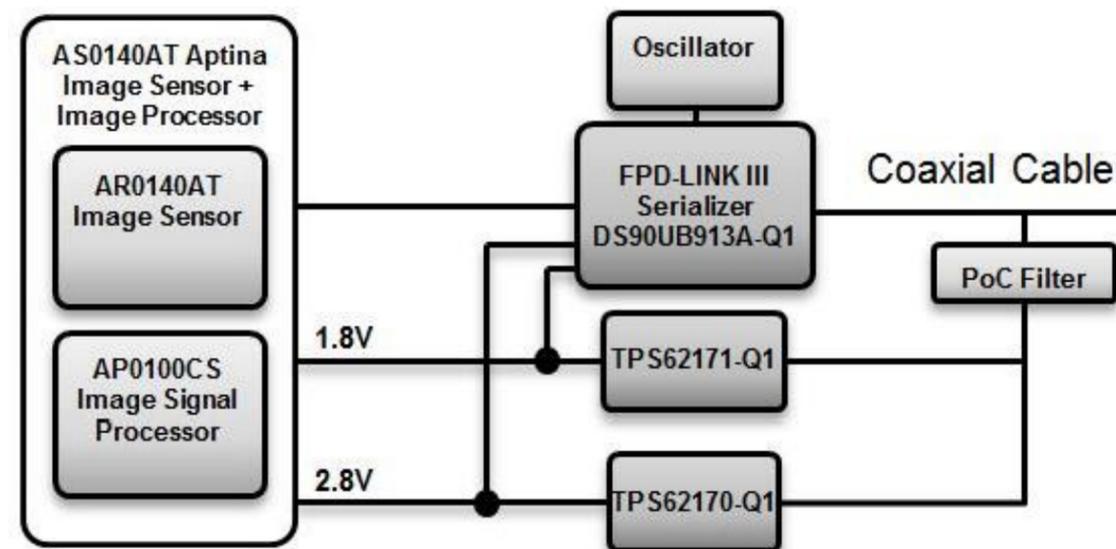


Revision History

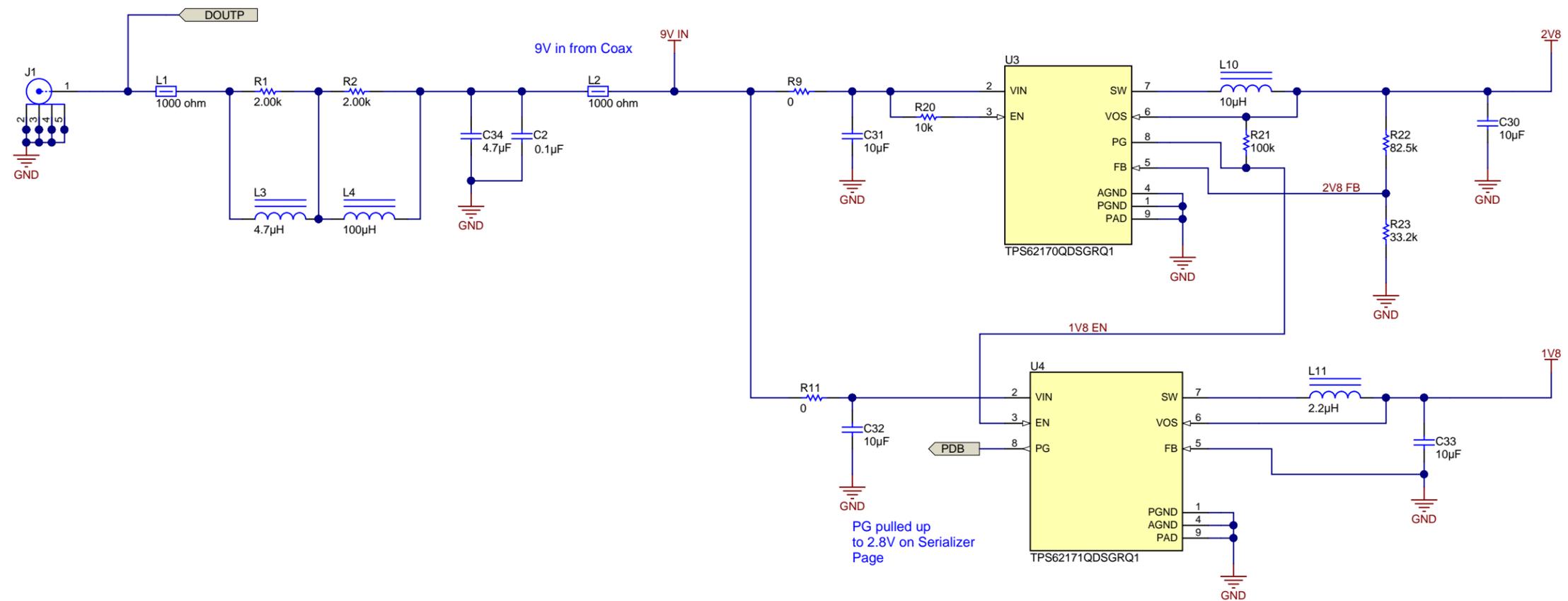
Rev	ECN #	Approved Date	Approved by	Notes
N/A	N/A	N/A	N/A	N/A



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TID #: TIDA-01002	Project Title: Automotive 1MP Camera Module with Image Correction		
Number: TIDA-01002	Rev: E3	Sheet Title:	
SVN Rev: Version control disabled	Assembly Variant: [No Variations]	Sheet: 1 of 5	
Drawn By:	File: CoverSheet.SchDoc	Size: B	
Engineer: Luis Cordova	Contact: http://www.ti.com/support		

Power over Coax Filter & Power Supply



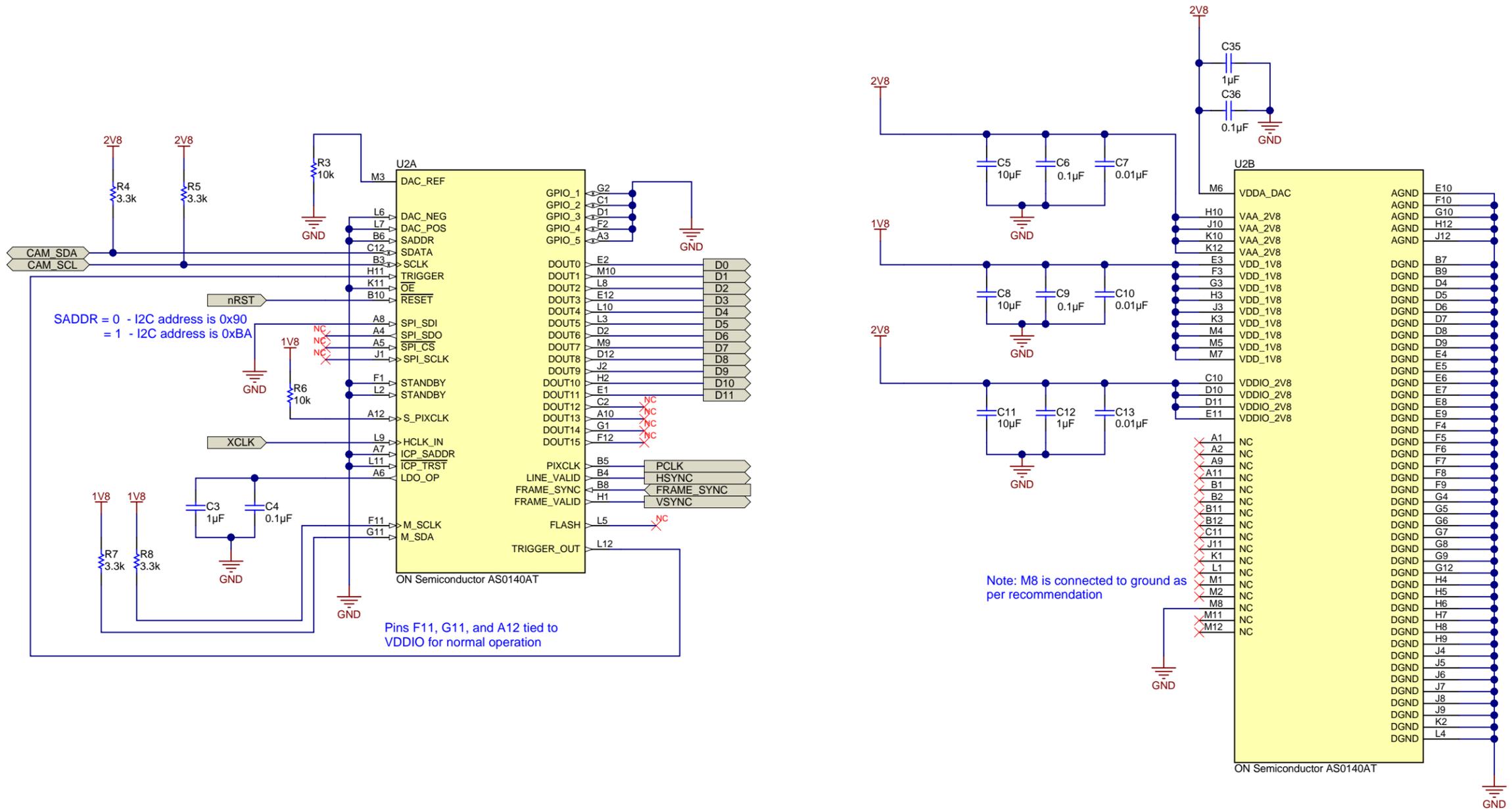
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Orderable: N/A	Designed for: Public Release	Mod. Date: 1/22/2018
TID #: TIDA-01002	Project Title: Automotive 1MP Camera Module with Image Correction	
Number: TIDA-01002	Rev: E3	Sheet: 2 of 5
SVN Rev: Version control disabled	Assembly Variant: [No Variations]	File: Power over Coax Filter & Power Supply.SchDoc
Drawn By:	Engineer: Luis Cordova	Contact: http://www.ti.com/support



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ON Semiconductor Imager + ISP



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TID #: TIDA-01002	Project Title: Automotive 1MP Camera Module with Image Correction	
Number: TIDA-01002	Rev: E3	Sheet: 3 of 5
SVN Rev: Version control disabled	Assembly Variant: [No Variations]	Sheet: 3 of 5
Drawn By:	File: ON Semiconductor AS0140AT Imager + ISP.SchDoc	Sheet: 3 of 5
Engineer: Luis Cordova	Contact: http://www.ti.com/support	Sheet: 3 of 5

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PCB Number: TIDA-01002
PCB Rev: E3

PCB
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Pb-Free Symbol

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FCC disclaimer

ZZ1
Assembly Note
These assemblies are ESD sensitive, ESD precautions shall be observed.

ZZ2
Assembly Note
These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.

ZZ3
Assembly Note
These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.

Orderable: N/A	Designed for: Public Release	Mod. Date: 1/24/2017	
TID #: TIDA-01002	Project Title: Automotive 1MP Camera Module with Image Correction		
Number: TIDA-01002	Rev: E3	Sheet Title:	
SVN Rev: Version control disabled	Assembly Variant: [No Variations]	Sheet: 5 of 5	
Drawn By:	File: TID_Hardware.SchDoc	Size: B	
Engineer: Luis Cordova	Contact: http://www.ti.com/support		http://www.ti.com © Texas Instruments 2016

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